# 506159582 07/17/2020

# PATENT ASSIGNMENT COVER SHEET

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## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16636746

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# **Total Attachments: 2**

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PATENT 506159582 REEL: 053242 FRAME: 0896

### OF ASSIGNMENT NO

For good and valuable consideration, the receipt of which is hereby acknowledged, paid to: **Takayoshi OKABE**, c/o The University of Tokyo, 3-1 Hongo 7-chome, Bunkyo-ku, Tokyo 113-8654 Japan (an undersigned Inventor), hereby sells and assigns to **The University of Tokyo**, having a place of business at 3-1 Hongo 7-chome, Bunkyo-ku, Tokyo 113-8654 Japan (the Assignee), and hereby confirms any prior sale and assignment to The University of Tokyo, his entire right, title and interest for the United States of America (as defined in 35 U.S.C. § 100) and throughout the World in all invention(s) described or claimed in applications for patent entitled:

Novel Amide Compound, and Pin1 Inhibitor, Therapeutic Agent for Inflammatory Diseases and Therapeutic Agent for Cancer That Use the Same

which applications for patent are also known as:

Japanese Patent Application No. 2017-152806 (filed August 7, 2017);

International Patent Application No. PCT/JP2018/029495 (filed August 6, 2018); and

United States Patent Application No. 16/636,746 (filed February 5, 2020):

and in any and all applications thereon, in any and all Letters Patent(s) therefor, and in any and all reissues, extensions, renewals, reexaminations of such applications or Letters Patent(s) and national stage, divisional, continuation and continuation-in-part applications thereof, to the full end of the term or terms for which such Letters Patent(s) issue, including all claims, if any, that may have arisen for infringement prior to the date of this Assignment, such entire right, title and interest to be held and enjoyed by the above-named Assignee to the same extent as they would have been held and enjoyed by the undersigned had this assignment and sale not been made.

The Undersigned Inventor agrees to execute all papers necessary in connection with the application(s) and any continuing (continuation, divisional, or continuation-in-part), reissue, reexamination or corresponding application(s) thereof and also to execute separate assignments in connection with such application(s) as the Assignee may deem necessary or expedient.

The Undersigned Inventor hereby represents that he or she has full right to convey the entire interest herein assigned, and that he has not executed, and will not execute, any agreement in conflict therewith.

The Undersigned Inventor hereby grants William C. Schrot, Reg. No. 48,447 and Jeffrey I. Auerbach, Reg. No. 32,680 the power to insert in this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

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IN WITNESS WHEREOF, executed by the Undersigned Inventor on the date opposite his name.

Date: June 29 2020

Signature of Takayoshi OKABE

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